# **The µ-RWELL for future HEP challenges** Review of the DDG activities

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## MPGD24, Oct $14^{th}$ 2024



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L2=101.71u

L7=48,18µr

## The **µ-RWELL**



# The low-rate layout: Single Resistive Layout (SRL)







- Single DLC layer
- Grounding at the perimeter of the active area
- Limitation for large area: detector response depends on particle incidence point
- Limited rate capability

## **DDG-LNF R&D PROJECTS**



## High rate $\mu\text{-}RWELL$ for the LHCb experiment

## LHCb upgrade II (Run5-6)

LHCb muon RUN 5-6 option:  $\mu$ -RWELL  $\rightarrow$  Detector requirements:

- Rate up to  $1\ MHz/cm^2$  on detector single gap
- Rate up to **700kHz** for FEE channel
- Efficiency (4 gaps) > **99% within BX** (25 ns)
- Stability up to 1 C/cm<sup>2</sup> accumulated charge in 10y of operation

Detector size & quantity (4 gaps/chamber)

• R1 + R2 of M2-M5: **576 det.**, size 30x25 to 74x31 cm<sup>2</sup>, **90 m<sup>2</sup> det** 





## M2 station - max rate (kHz/cm<sup>2</sup>)



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# High-rate layouts: principle of operation



To overcome the **intrinsic rate limitations** of the Single Resistive Layout, it is necessary to introduce a **high-density grounding network** for the resistive stage (DLC).



Single Resistive Layout (SRL)



**Segmentation of the DLC** with conductive microstrips/dots with a typical pitch of 1cm: a sort of **tiling** of the active area using a set of smaller SRL.

## The PEP-DOT µ-RWELL

DLC-GND	Dead Zone	GND width	Insulation	DOCA
pitch [mm]	[mm]	[mm]	gap [mm]	[mm]
9	1.3 (1.6%)	0.767	0.175	0.535





- The most recent high rate layout: Patterning-Etching-Plating
- The DLC ground connection is established by creating metalized vias from the top Cu layer through the DLC, down to the pad-readout of the PCB
- The dead zone is  $\sim 2\%$



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## **PEP-dot – results**







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## **PEP-dot – results**







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# Tracking $\mu\text{-RWELL}$ for FCC-ee

# FCC-ee $\rightarrow$ $\mu\text{-RWELL}$ for tracking and muon system

The **IDEA detector** is a general purpose detector designed for experiments at future e<sup>+</sup>e<sup>-</sup> colliders.

**Pre-shower detector** and the **Muon system** are designed to be instrumented with  $\mu$ -RWELL technology.



### Requirements

**Tiles: 50x50 cm<sup>2</sup> with X-Y readout** Efficiency >98% Space resolution:

- 100µm (preshower)
- 500µm (muon)

### **Instr. surface/FEE**

Preshower:

- \* 130m², 520 det., 3x10 $^{\scriptscriptstyle 5}$  chs. (0.4 mm strip pitch) Muon:
- 1500m<sup>2</sup>, 6000 det., 5x10<sup>6</sup> chs., (1.2mm strip pitch)

### **GOALS:**

Mass production  $\rightarrow$  Technology Transfer to Industry FEE cost reduction  $\rightarrow$  custom made ASIC

See <u>R. Farinelli's talk</u> on 15th Oct.:  $\rightarrow$  µ-RWELL muon system and pre-shower for FCC-ee

# **2-D Tracking layouts**

### n.2 μ-RWELL 1D [2×1D]



The layout with **two separate detectors** equipped with its own r/out is operated at lower gas gain, with respect to the single detector with 2D R/O (COMPASSlike) - <u>Tested @ TB2022</u>

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The layout with **two separate detectors** equipped with its own r/out is operated at lower gas gain, with respect to the single detector with 2D R/O (COMPASSlike) - <u>Tested @ TB2022</u> Pad layers X & Y

Cathode

The charge sharing through the **capacitive coupling** between a stack of layers of pads and the R/O board. Reduce the FEE channels, and **the total charge is divided between the X & Y** R/O - Tested @ TB2023

[\*] K. Gnanvo et al., NIM A 1047 (2023) 167782 MPGD24 - M. Giovannetti - u-RWELL for future HEP

# **2-D Tracking layouts**

## n.2 μ-RWELL 1D [2×1D]

## Y-strips Drift gap Common Cathode Drift gap X-strips

The layout with **two separate detectors** equipped with its own r/out is operated at lower gas gain, with respect to the single detector with 2D R/O (COMPASSlike) - <u>Tested @ TB2022</u> Capacitive Sharing [\*]



Cathode Drift gap Y-strips (top) X-strips (R/O)

Top R/O

The charge sharing through the **capacitive coupling** between a stack of layers of pads and the R/O board. Reduce the FEE channels, and **the total charge is divided between the X & Y** R/O - <u>Tested @ TB2023</u> The TOP-readout layout allows to work at lower gas gain w.r.t a COMPASS-like R/O: X-Y are decoupled. X-coordinate on the TOP of the amplification stage introduces **dead zone** in the active area - <u>Tested @ TB2023</u>

[\*] K. Gnanvo et al., NIM A 1047 (2023) 167782 MPGD24 - M. Giovannetti - u-RWELL for future HEP

# 2D tracking layout performance



**2x1D:** spatial resolution < 200um (pitch 0.8 mm), low voltage operating point  $\approx$  520V, efficiency  $\approx$  95% **CS:** spatial resolution <200um (with pitch 1.2 mm), high voltage operating point,  $\geq$  **600V**, efficiency  $\approx$  98% **TOP R/O:** spatial resolution < 200um (pitch 0.8 mm), low voltage operating point  $\approx$  520V, efficiency  $\equiv$  70%

In collaboration with G. Cibinetto, R. Farinelli, L. Lavezzi, M. Gramigna, P. Giacomelli, E. De Lucia, D. Domenci, A. D'angelo, M. Bondi, M. Scodeggio, I. Garzia, M. Melindi

See <u>R. Farinelli's talk</u> on 15th Oct.  $\rightarrow \mu$ -RWELL muon system and pre-shower for FCC-ee

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## **µ-RWELL + GEM preamplification**

#### Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401-404



## Development of $\mu\textsc{-}\mathsf{RWELL}$ detectors for the upgrade of the tracking system of CMD-3 detector



L. Shekhtman<sup>\*</sup>, G. Fedotovich, A. Kozyrev, V. Kudryavtsev, T. Maltsev, A. Ruban Budker Institute of Nuclear Physics, 630090, Novosibirsk, Russia Novosibirsk Stue University, 630090, Novosibirsk, Russia

ARTICLE INFO	ABSTRACT				
Keywords:	An upgrade of trackin				
Tracking detectors	technology. CMD-3 i				
Micro-RWELL	Nuclear Physics and i				
Micro-pattern gas detectors	The new subsystem of				
	RWELL and micro-R				

An upgrade of tracking system of Cryogenic Magnetic Detector (CMD-3) is proposed using microresistive WELL technology. CMD-3 is a general purpose detector operating at the VEPP-2000 collider at Buddker Institute of Nuclear Physics and intended for studies of light vector mesons in the energy range between 0.3 GeV and 2 GeV. The new subsystem consists of double-layer cylindrical detector and the end-cap discs. Two prototypes, micro-RWELL and micro-RWELL-GEM were built and tested. Gas amplification of micro-RWELL detector was measured with several gas mixtures and maximum gain between 2000 and 30000 was observed. However, maximum gain is fluctuating from measurement to measurement by a factor of 2 and thus a safety margin of 2–3 is needed to provide reliable operation of the device. In order to increase the signal GEM was added to micro-RWELL, new prototype was tested with the same gas mixtures and gains above 10<sup>5</sup> have been demonstrated. Time resolution achieved for both prototypes are 7 ns for micro-RWELL and 4 ns for micro-RWELL, and 4.

L. Shekhtman, Nuclear Inst. and Methods in Physics Research, A 936 (2019) 401-404



## µ-RWELL + GEM – gas gain

### VERY PRELIMINARY: 9-Oct-2024

### 3 different gains for the $\mu$ -RWELL

**3 different detectors** 



GEM gain @ 450V ≈ 20

A very stable detector: it doesn't show any hint of instabilities even at **60k**. We stopped because the FEE will surely saturate at that point

Planned to be tested as soon as possible with APV25. Goal: space resolution with a COMPAS-like readout.

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## **Cylindrical-RWELL for low-momentum experiments**

# Low X<sub>0</sub> Cylindrical µ-RWELL

Thanks to the LNF and INFN-Fe Eurizon collaboration



Exploiting the **flexible** characteristic of the amplification stage of the  $\mu$ -RWELL, as well as the readout  $\rightarrow$  development of a **lowmass (0.6÷1% X0) modular Inner Tracker** for low-energy e<sup>+</sup>e<sup>-</sup> colliders: the **C-WELL**.

- From standard  $\mu$ -RWELL on rigid PCB supports  $\rightarrow$  a full flexible detector tile
- **Three tiles** have been glued on composite/foam roof-tiles, then mounted on the anode cylindrical support
- A **full cylindrical-cathode** will close (externally) the detector





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## The roof-tile assembly



The roof tile is composed of a Structural Adhesive Film (30  $\mu$ m) coupled to a layer of Millifoam® (2 mm) where the flexible PCB is glued, under vacuum, with epoxy.



The roof-tile Millifoam support



Gluing the  $\mu$ -RWELL-PCB onto the roof tile, followed by an epoxy curing cycle under vacuum.



The flexible  $\mu\text{-}RWELL$  PCBs produced at CERN-EP-DT MPT Workshop. Each foil is divided in four HV sectors



The final rooftile is coupled to the anode support

## **Final assembly**

# Cosmic ray test

European network for developing new horizons for RIs

The final assembly **didn't require a highly sophisticated sliding machine**, thanks to the **large distance (10 mm)** between the roof tiles and the internal surface of the cathode. The tile gluing and the detector assembly took **14 days**.





Tracking system: 4 1D  $\mu\text{-RWELLs}$  Gas: Ar:CO\_2:CF\_4 45:15:40

 $\rightarrow$  large residuals due to inclined tracks





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## **Technology Transfer to Industry**





Step 0 - Detector **PCB design** @ LNF + CERN-MPT

Step 1 - CERN\_INFN DLC sputtering machine @ CERN (+INFN)

- In operation since Nov. 2022
- Production by LNF-INFN crew
- Step 2 Producing readout PCB by ELTOS
- pad/strip readout



- Step 3 **DLC patterning** by ELTOS
  - photo-resist  $\rightarrow$  patterning with BRUSHING-machine

## Step 4 – **DLC foil gluing** on PCB by ELTOS

Large press available, up to 16 PCBs workable at the same time

## Step 5 - Ground network connections creation by CERN

**PEP** layout: Cu **P**atterning  $\rightarrow$  PI **E**tching  $\rightarrow$  Cu **P**lating

## Step 6 - Amplification stage patterning by CERN

- Cu amplification holes image and HV connections by Cu etching
- PI etching  $\rightarrow$  plating  $\rightarrow$  amplification-holes

## Step 7 – Electrical cleaning and detector closing @ CERN



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# **Update on the DLC Sputtering**



The **CID** (CERN-INFN-DLC) sputtering machine, a **joint project between CERN and INFN**, is used for preparing the **base material of the detector**. The potential of the DLC sputtering machine is:

- Flexible substrates up to 1.7×0.6m<sup>2</sup>
- **Rigid substrates** up to **0.2×0.6m**<sup>2</sup>

In **2023**, the activity on CID focused on the **tuning** of the **machine on small foils: good** results in terms of **reproducibility and uniformity**.

In **2024**, the challenge is the **sputtering of large foils**:

- **DLC+Cu** sputtering on 0.8×0.6m<sup>2</sup> successfully done (May/June 2024)
- DLC on 1.7×0.6m<sup>2</sup> large 0/50/0 Apical foils successfully done (June 2024)
- DLC on 1.7×0.6m<sup>2</sup> large 5/50/0 Apical foils successfully done (July 2024)



Ar 150 sccm, C<sub>2</sub>H<sub>2</sub> 3 sccm, p<sub>proc</sub> 2E-3 mbar





Many thanks to the CID team!!



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# 2023 – 10x10 co-production pilot test





-/DDG/lavori/AIDAinnova/2023-12\_prepreg\_thick/analys

## July 2024 - M2R1 prototypes





Large size detectors are right now under test

**30x25cm<sup>2</sup> active area 952 R/O pads** (9x9mm<sup>2</sup>)



## 10x10 and M2R1 - summary





The gas gain calibration curve are very similar, thus the process for creating the amplification stage is stable and doesn't depend on the size of the detector.

Correlation: the max-gain increases with the DLC resistivity.

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The gas gain calibration curve are very similar, thus the process for creating the amplification stage is stable and doesn't depend on the size of the detector.

Correlation: the max-gain increases with the DLC resistivity.

It seems that large size detector maximum gain is lower that the 10x10 one.

## **Thermal neutron detection**

# **Thermal neutron detection** (with sRPC)

## A parallel R&D w.r.t. the $\mu$ -RWELL one

# The sRPC hybrid layout

**Detecting thermal neutrons** ( $E_k \sim 25 \text{meV}$ ) with <sup>10</sup>B<sub>4</sub>C:

- <sup>10</sup>B<sub>4</sub>C deposition on one of the two detector electrodes (ρ≈2 MΩ/□) - Neutron converts in ionizing particle: **α**/<sup>7</sup>Li back to back

 $n + {}^{10}_{5}B \begin{cases} {}^{7}_{3}Li(1.02MeV) + \alpha(1.78MeV) & 6\% \\ {}^{7}_{3}Li(0.84MeV) + \alpha(1.47MeV) + \gamma(0.48MeV) & 94\% \end{cases}$ 

 $\label{eq:Goal: Simplify the detector layout} and reduce \ production \ costs$ 

A new sRPC hybrid layout: <sup>10</sup>**B4C cathode** and a **float-glass anode** (HV through graphite coating, GSC-like [\*]).





**Cosmic rays vs 25meV neutrons** 

[\*] M. Anelli et al., Glass electrode spark counters, Nucl. Instr. & Meth. A 300 (1991) 572.

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## Summary

The  $\mu$ -RWELL is an established technology, with good performances. Our recent R&Ds focus mainly on increasing the **stability** of the detector and the **semplicity** of the production.

**LHCb** - the **PEP-DOT** is the most recent high rate scheme

→ The 10x10 prototypes satisfy the LHCb requirements, with a gas gain  $\approx 10^4$ , a rate capability **O(1MHz/cm<sup>2</sup>)** and a good time resolution (**7ns**, up to now dominated by the FEE).

**RD-FCC/IDEA** – see R. Farinelli's talk → μ-RWELL muon system and pre-shower for FCC-ee → **GEM preamp** stage: high gas gain (**6·10**<sup>4</sup>), expected good performance with a COMPASS-like R/O

**C-WELL** – R&D completed with the proof of concept of the detector

 $\rightarrow$  The **modular geometry** works correctly, it was validated with **cosmic rays tracks** 

Technology Transfer - establishing the PEP-DOT pipeline with ELTOS and CERN

 $\rightarrow$  The DLC machine team is able to sputter large size foils with DLC or DLC+Cu

 $\rightarrow$  Four  $30x25cm^2$  high rate  $\mu$ -RWELLs are right now under test. A Beam Test is planned in Novemember.

**Thermal Neutron Detection** – Thermal neutron detectors based on Resistive Gaseous Detectors and <sup>10</sup>B<sub>4</sub>C converters have been successfully developed & tested.

 $\rightarrow$  The sRPC hybrid layout (GSC-like anode) shows good stability and promising results

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# Spare



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## The µ-RWELL: detector scheme

The  $\mu$ -RWELL is a Micro Pattern Gaseous Detector (MPGD) composed of only two elements: the  $\mu$ -RWELL\_PCB and the cathode. **The core is the \mu-RWELL\_PCB**, realized by coupling three different elements:



Applying a suitable voltage between the **top Culayer and the DLC** the WELL acts as a **multiplication channel for the ionization** produced in the conversion/drift gas gap.





## Rate capability vs spot-size & detector size

**Comparison between** a **model** of the resistive stage and **measurements** of the rate capability for SRL

1. detectors with same size (d) but different resistivity exhibit a rate capability scaling as the inverse of their resistivity.

2. for the SRL, increasing the active area from 10x10 cm2 to 50x50 cm2 the rate capability should go down few kHz/cm<sup>2</sup>.

3. By using a **DLC** ground **sectoring every 10 cm**, large (50x50cm2) detectors could achieve **rate capability up to 100kHz/cm**<sup>2</sup> (with X-ray).

Different primary ionization ⇒ Rate Cap.<sub>m.i.p.</sub> = 3×Rate Cap.<sub>X-ray</sub>



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## **The High Rate layouts**





A conductive grid is patterned on the back of special DLC foils (DLC + Cu technology: delicate manufacturing process).

Necessity to introduce a **small DEAD AREA** above the grid, to avoid discharges (tuned to be 5% of the total area).

**NOT SCALABLE** to large size: distortions and alignment problems **during manufacturing**.

IS POSSIBLE to **check the resistance** of the layer after the detector is built



Based on a **3-D** current evacuation scheme: Two stacked resistive layer connected through a **matrix of conductive vias,** grounded through a further matrix of vias to the underlying readout electrodes.

MORE COMPLEX to buid **than SG** but reliable (for now only 10x10 prototypes). **NOT POSSIBLE to check the resistance** of the two layers after the manifacture.

# FATIC2 block diagram



### **Preamplifier features:**

- CSA operation mode
- Input signal polarity: positive & negative
- Recovery time: adjustable

## CSA mode:

- Programmable Gain: 10 mV/fC ÷ 50 mV/fC
- Peaking time: 25 ns, 50 ns, 75 ns, 100 ns

### Timing branch:

- $\checkmark$  Measures the arrival time of the input signal
- ✓ Time jitter: 400 ps @ 1 fC & 15 pF (Fast Timing MPGD)

### Charge branch:

- ✓ Acknowledgment of the input signal
- Charge measurement: dynamic range > 50 fC, programmable charge resolution

## Hybrid – Ed Et scan

## VERY PRELIMINARY: 9-Oct-2024



#### Drift [V/cm]

● I\_DLC ● I\_CAT ● I\_G\_TOP ● I\_G\_BOT ● I\_TOP





● I DLC ● I CAT ● I G TOP ● I G BOT ● I TOP



Drift [V/cm]

Hybrid 2 - Transfer scan @ Ed=3.5



Transfer gap: 3mm

Drift gap:

6mm

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## XO for Low Mass µ-RWELL

		<u>Thikcness</u>	(um) X0 (d	cm)	% X0			Glue	0		33.5	0.000
4	Cu Ground FEE	3		1.43	0.021		Tile BaseLine	kapton	0		28.6	0.000
	kapton	50		28.6	0.017			Glue	0		33.5	0.000
por	glue	25		33.5	0.007			MILLIFOAM	0		1312.5	0.000
dng	FR4	100		19.3	0.052			Glue	0		33.5	0.000
le o	glue	25		33.5	0.007			Kapton	0		28.6	0.000
ŏŭ	MILLIFOAM	3000	1	312.5	0.023							0.000
◄	glue	25		33.5	0.007							
	FR4	100		19.3	0.052				Tot.		node	0.378
					0.187							
							hoc	Cu	3		1.43	0.021
							e Support + Cat	kapton	50		28.6	0.017
ge	Cu	5		1.43	0.035			glue	25		33.5	0.007
sta	kapton	50		28.6	0.017			FR4	100		19.3	0.052
ġ.	DLC	0.1		12.1	0.000			glue	25		33.5	0.007
An	Pre-preg (106)	50		19.3	0.026			MILLIFOAM	3000		1312.5	0.023
					0.078		por	glue	25		33.5	0.007
							ath	FR4	100		19.3	0.052
							age	glue	25		33.5	0.007
Anode 2D	Cu	5		1.43	0.035		<u></u>	kapton	50		28.6	0.017
	kapton	50		28.6	0.017		Fai	Cu Ground	3		1.43	0.021
	glue	25		33.5	0.007							0.233
	Cu	5		1.43	0.035							
	kapton	50		28.6	0.017					<u>&gt;</u>	(0 - single	0.611
					0.112					<mark>)</mark>	(0 B2B	0.99

# **ELTOS production – DLC patterning**

### <u>Step 2:</u>

1) R/O **PCB** production

## <u>Step 3:</u>

- 2) Photoresist **lamination** for DLC protection
- 3) Photoresist UV-**exposure**
- 4) Photoresist **development**
- 5) **DLC patterning** with brushing machine (@CERN different approach: JET-SCRUBBING)















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# ELTOS production – DLC-foil gluing

Step 4: Cu-Kapton-DLC gluing on PCB

between DLC and R/O pad.

16 PEP-dot detectors ( $9 \times 9$ mm<sup>2</sup> pad R/O),

**11/16** detector **delivered/tested** up to now

Study of signal **pulse amplitude vs coupling capacitance** 

with **different pre-preg thickness** 

## Main parameters: Pressure 180 N/cm<sup>2</sup> Temperature 210 °C Press-top pacothane Cu+Kapton+DLC n.1 PANASONIC R-1551W tipo106 PCB-1.6mm n.2 Pacoflex(1000)-250 um



 $\Delta x [\mu m]$ 

50

75

100

150

**Pre-preg** 

106

1080

x2 106

x2 1080



•

# July 2024 - M2R1 prototypes





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# The sRPC – Surface vs Bulk



## **Classical RPCs**

- Bulk resistivity electrodes (bakelite, float-glass, ...)
- Recovery time proportional to **volume resistivity, electrode thickness** 
  - $\circ \tau = \rho_V \epsilon_0 (\epsilon_r + 2d/g)$
  - $\circ$  Low volume resistivity and thin electrodes, together with the reduction of the gas gain ( $\oplus$ high gain low noise pre-amp) is the standard recipe to increase the detector rate capability.



## **sRPCs - surface RPC**

- Surface resistivity electrodes manufactured with sputtering techniques of Diamond-like-carbon (DLC) on flexible supports
- High density current evacuation schemes, similar to those used for resistive MPGD ( $\mu$ -RWELL and MicroMegas), can be implemented to improve the rate capability of the detector

# The sRPC – an MPGD-tech based RPC

0.1

8.6

8.8

9

9.2

9.4



G. Bencivenni et al., 2023 JINST 18 C06026



9.8

9.6

MPGD24 - M. Giovannetti - u-RWELL for future HEP

10

HV [kV]

86

~/DDG/lavori/20220907\_sRPC\_doca/eff\_202209\_workshop\_timin

v 2022/09/20

88

9

92

9.4

9.6

9.8

10

50

10.2

HV [kV]

# sRPC for thermal neutron detection

## Detecting thermal neutrons ( $E_{\rm k}$ ~25meV) with $^{10}B_4C$ :

- ${}^{10}B_4C$  deposition on one of the two detector electrodes ( $\rho \approx 2 M\Omega/\Box$ )
- Neutron converts in ionizing particle:  $\alpha/^{7}Li$  back to back

n+<sup>10</sup><sub>5</sub>B  $\begin{cases} {}^{7}_{3}Li(1.02MeV) + \alpha(1.78MeV) & 6\% \\ {}^{7}_{3}Li(0.84MeV) + \alpha(1.47MeV) + \gamma(0.48MeV) & 94\% \end{cases}$ 

- ${}^{10}B_4C$  planar converter thickess optimization from  $\mu$ -RWELL experience: 2.5  $\mu m$  thick  $\rightarrow$  expected 4% efficiency
  - Expected  $\epsilon \sim 8\%$  for single sRPC (2 converter electrodes)
  - $\circ$  ~ Simple detector  $\rightarrow$  possible to make a stack w/ more layer
- sRPC as neutron detector is operated at much lower voltage than for m.i.p. due to the larger ionization of  $\alpha$  and <sup>7</sup>Li ( $\approx$ 20k e<sup>I+</sup> pairs)



- $\alpha/^{7}$ Li emission is **uniform** 
  - $\Rightarrow$  they enter the gas gap with a random angle.
- $\alpha/^{7}$ Li mean path is shorter than 2mm
  - $\Rightarrow$  cathode and anode have different behaviours

# uRANIA sRPC – first results



neutron <sup>7Li/α</sup> -HV <sup>10</sup>B<sub>4</sub>C CATODE α/<sup>7</sup>Li DLC +HV



Measured performed at HOTNES thermal neutron source, w/ 3 prototypes.

- ${}^{10}B_4C$  CAT DLC AN : the expected 4% plateau was reached
- DLC CAT  ${}^{10}B_4C$  AN : efficiency strongly depends on the HV/gain due to small signals
- ${}^{10}B_4C$  CAT  ${}^{10}B_4C$  AN : the "double  ${}^{10}B_4C$  prototype performs as the SUM of the two